

TFN 2814



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the application of
HORNING et al.

Serial Number:
09/873,931

Filed: June 4, 2001

For:
APPLICATIONS OF A
STRAIN-COMPENSATED
HEAVILY DOPED ETCH STOP
FOR SILICON STRUCTURE
FORMATION

Group Art Unit:
2814

Examiner:
Steven H. Rao

Docket No. 16-16009 US

To the Commissioner of Patents and Trademarks:

Sir:

AMENDMENT

Please enter the following amendments in response to the Office
Action mailed January 4, 2006.